

# QPA1000 2.8 – 3.2 GHz 50 Watt GaN Amplifier

#### **Product Description**

Qorvo's QPA1000 is a high-power, S-band amplifier fabricated on Qorvo's QGaN25 0.25 um GaN on SiC production process. Covering 2.8 – 3.2 GHz, the QPA1000 typically provides 47 dBm of saturated output power and 22 dB of large-signal gain while achieving 58 % power-added efficiency.

The QPA1000 can also support a variety of operating conditions to best support system requirements. With good thermal properties, it can support a range of bias voltages and will perform well under pulse applications. The QPA1000 is matched to 50 ohms with integrated DC blocking caps on both I/O ports. It is ideal for use in both commercial and military radar systems.

Lead-free and RoHS compliant.

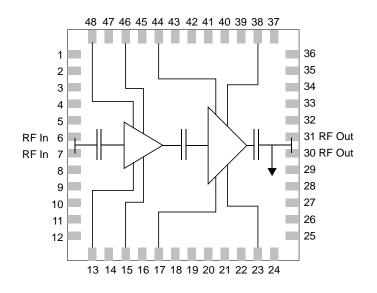
# QOCYO QPA1000

#### **Product Features**

- Frequency Range: 2.8 3.2 GHz
- Pout: 47 dBm (P<sub>IN</sub> = 25 dBm)
- Large Signal Gain: 22 dB (P<sub>IN</sub> = 25 dBm)
- PAE: 58 % (P<sub>IN</sub> = 25 dBm)
- Bias:  $V_D = 25 \text{ V}$ ,  $I_{DQ} = 200 \text{ mA}$ ,  $V_G = -2.8 \text{ V}$  (Typ)
- Supports Long Pulse Operation
- Package Dimensions: 7.0 x 7.0 x 0.85 mm

Performance is typical across frequency. Please reference electrical specification table and data plots for more details.

#### **Functional Block Diagram**



#### **Applications**

- Military Radar
- Commercial Radar

#### **Ordering Information**

Part	Description		
QPA1000	2.8–3.2 GHz 50 W GaN Power Amplifier		
QPA1000EVB	QPA1000 Evaluation Board		



#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

#### **Absolute Maximum Ratings**

Parameter	Value / Range
Drain Voltage (V <sub>D</sub> )	40 V
Drain Current (I <sub>D1</sub> /I <sub>D2</sub> )	0.77 / 3.84 A
Gate Voltage Range	-8 to 0 V
Gate Current (I <sub>G</sub> )	See plot page 9
Dissipated Power (P <sub>DISS</sub> ) <sup>1</sup>	44.25 W
Input Power (50 Ω, 85 °C)	33 dBm
Input Power (9:1 VSWR, 85 °C)	33 dBm
Mounting Temperature (30 seconds)	260 °C
Storage Temperature	−55 to 150 °C

#### Note:

Operation of this device outside the parameter ranges given above may cause permanent damage. These are stress ratings only, and functional operation of the device at these conditions is not implied.

#### **Recommended Operating Conditions**

Parameter	Value
Drain Voltage	25 V
Drain Current (quiescent, IDQ)	200 mA
Drain Current (under drive, I <sub>D</sub> )	3.7 A
Gate Voltage	-2.8 V
Operating Temperature Range	−40 to 85 °C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions.

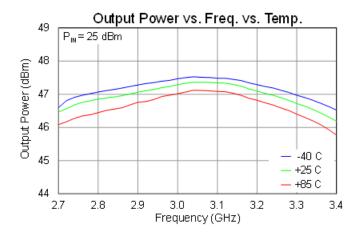
#### **Electrical Specifications**

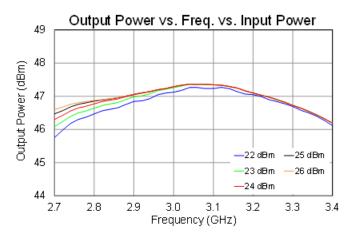
Parameter	Min	Тур	Max	Units
Operational Frequency Range	2.8	3.0	3.2	GHz
Output Power (P <sub>IN</sub> = 25 dBm)	46	47		dBm
PAE (P <sub>IN</sub> = 25 dBm)	50	58		%
Small Signal Gain		25		dB
Input Return Loss		11		dB
Output Return Loss		13		dB
2 <sup>nd</sup> Harmonic		-27		dBc
3 <sup>rd</sup> Harmonic		-43		dBc
Output Power Temperature Coefficient		-0.004		dBm/°C
Recommended Operating Drain Voltage			25	V

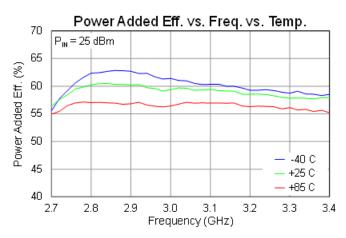
 $<sup>^{1}</sup>$  T<sub>BASE</sub> = 85 °C, T<sub>CH</sub> = 225 °C

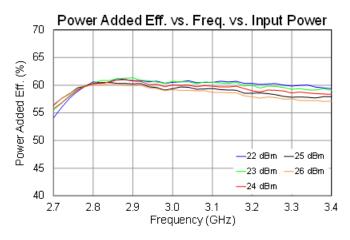
#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

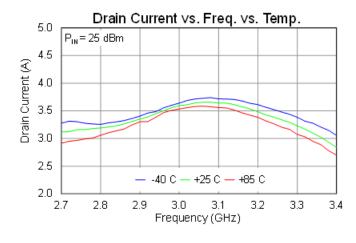
#### Performance Plots - Large Signal (Pulsed)

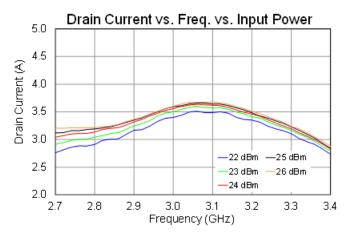








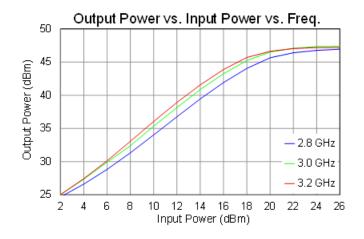


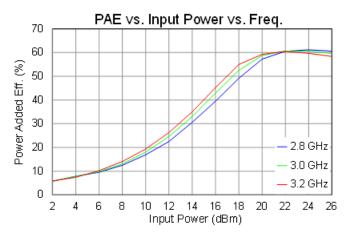


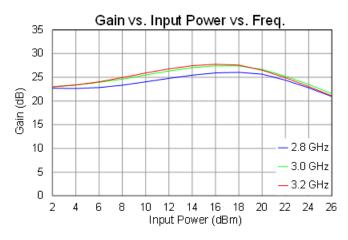


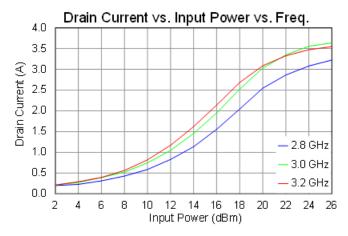
#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

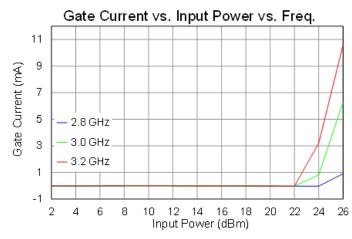
#### Performance Plots - Large Signal (Pulsed)









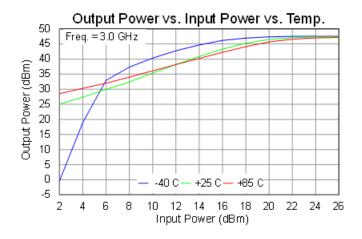


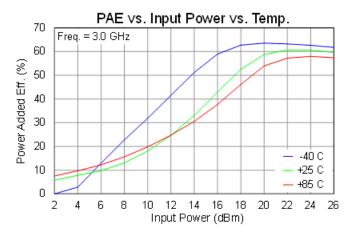


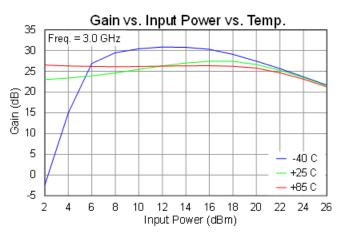


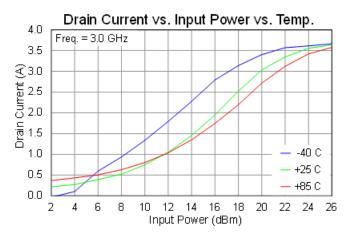
#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

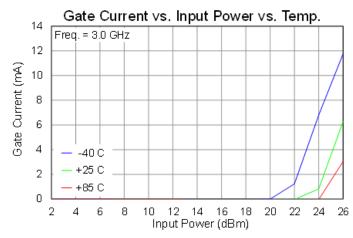
#### Performance Plots - Large Signal (Pulsed)









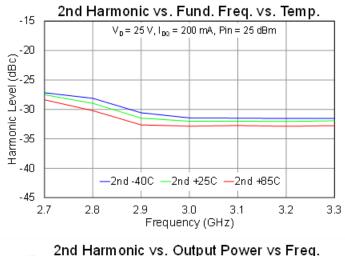


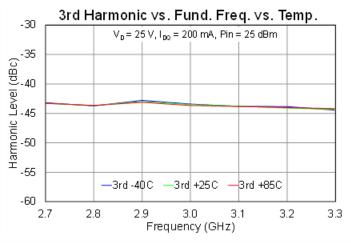


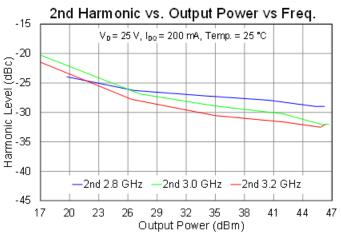


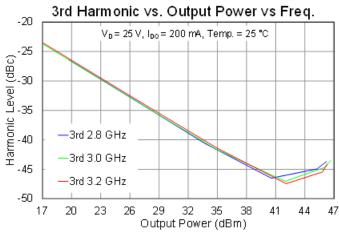
#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

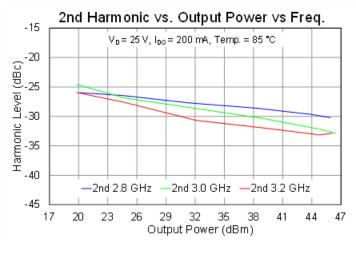
#### **Performance Plots – Harmonics**

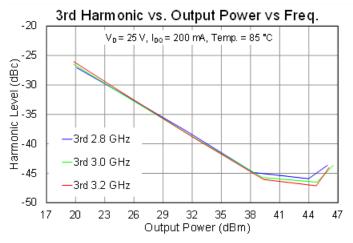








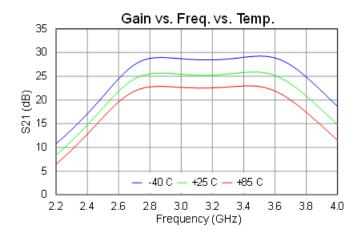


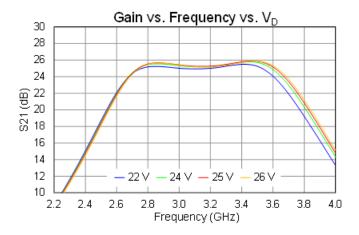


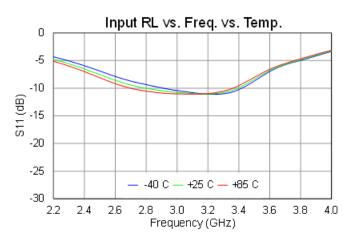
#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

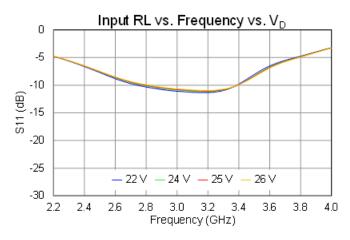
# Performance Plots - Small Signal

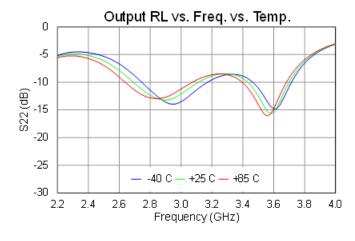
Test conditions unless otherwise noted: Temp. = 25 °C, V<sub>D</sub> = 25 V, I<sub>DQ</sub> = 200 mA

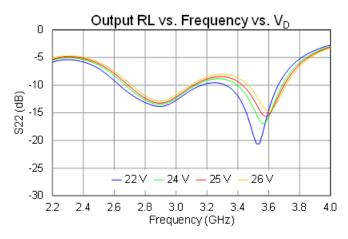








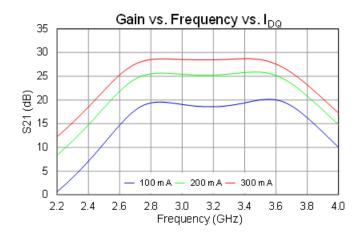


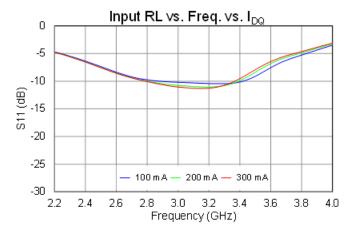


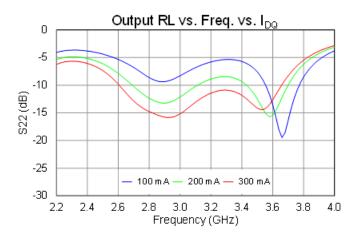
#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

#### Performance Plots - Small Signal

Test conditions unless otherwise noted: Temp. = 25 °C, V<sub>D</sub> = 25 V, I<sub>DQ</sub> = 200 mA







#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

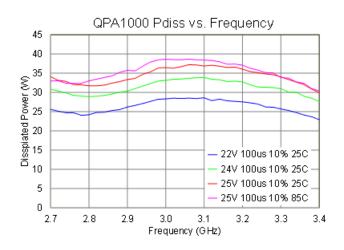
#### **Thermal and Reliability Information**

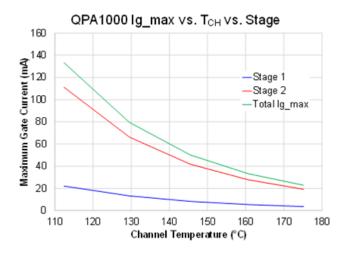
Parameter	Test Conditions	Value	Units
Thermal Resistance (θ <sub>JC</sub> ) <sup>(1)</sup>	T <sub>base</sub> = 85°C	0.6	°C/W
Channel Temperature (T <sub>CH</sub> ) (Quiescent)	$V_D = 25 \text{ V}, I_{DQ} = 200 \text{ mA}$ $P_{DISS} = 5.0 \text{ W}$	88	°C
Thermal Resistance (θ <sub>JC</sub> ) <sup>(1)</sup>	$T_{base} = 85^{\circ}C$ , $V_{D} = 25 \text{ V}$ , $I_{DQ} = 200 \text{ mA}$ , $F_{req} = 2.8 \text{ GHz}$ ,	0.65	°C/W
Channel Temperature (T <sub>CH</sub> ) (Under RF drive)	$I_{D\_Drive} = 3.6 \text{ A}, P_{IN} = 26 \text{ dBm}, P_{OUT} = 46.6 \text{ dBm}, P_{DISS} = 33.9 \text{ W}, PW = 100 \text{ us}, DC = 10\%$	107	°C
Thermal Resistance (θ <sub>JC</sub> ) <sup>(1)</sup>	$T_{base} = 85^{\circ}\text{C}, V_D = 25 \text{ V}, I_{DQ} = 200 \text{ mA}, Freq} = 3.1 \text{ GHz},$	0.66	°C/W
Channel Temperature (T <sub>CH</sub> ) (Under RF drive)	$I_{D\_Drive} = 3.8 \text{ A}, P_{IN} = 26 \text{ dBm}, P_{OUT} = 47.1 \text{ dBm},$ $P_{DISS} = 39.4 \text{ W}, PW = 100 \text{ us}, DC = 10\%$	111	°C

#### Notes:

- 1. Thermal resistance measured to back of package.
- 2. Refer to the following document: GaN Device Channel Temperature, Thermal Resistance, and Reliability Estimates

#### **Power Dissipation and Maximum Gate Current**

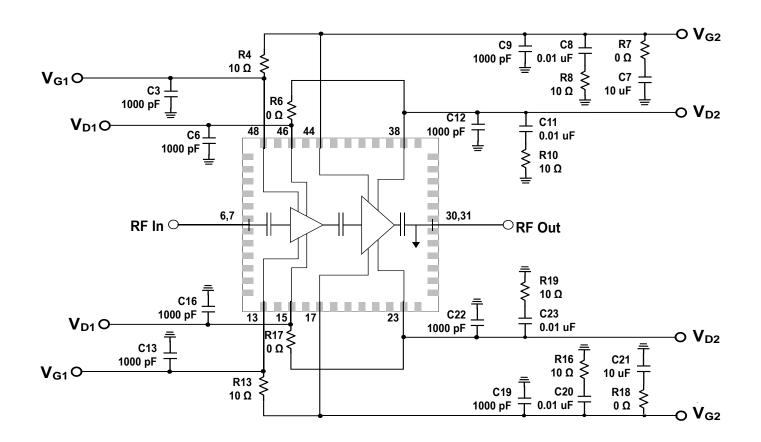








#### **Applications Circuit**



Notes:

1. V<sub>G</sub> and V<sub>D</sub> must be biased from both sides (top and bottom).

#### **Bias Up Procedure**

1. Set I <sub>D</sub> limit to 6000 mA, I <sub>G</sub> lim
--

- 2. Set V<sub>G</sub> to -6.0 V
- 3. Set V<sub>D</sub> +25 V
- 4. Adjust V<sub>G</sub> more positive until I<sub>DQ</sub> = 200 mA
- 5. Apply RF signal

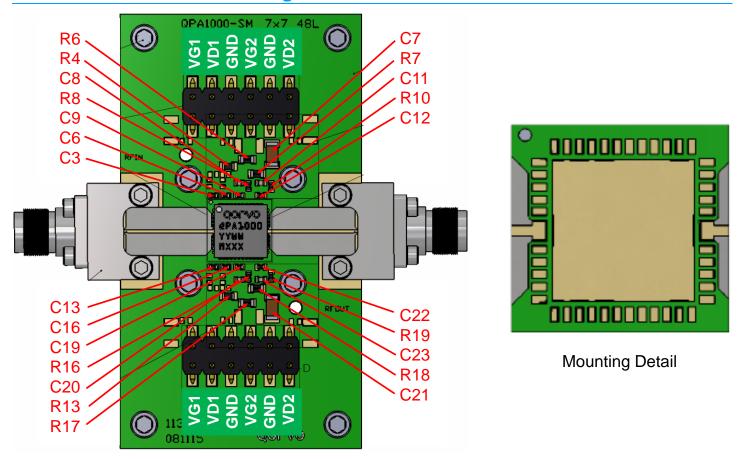
#### **Bias Down Procedure**

- 1. Turn off RF supply
- 2. Reduce  $V_G$  to -6.0 V. Ensure  $I_{DQ} \sim 0$  mA
- 3. Set  $V_D$  to 0 V
- 4. Turn off V<sub>D</sub> supply
- 5. Turn off V<sub>G</sub> supply





#### **Evaluation Board and Mounting Detail**



RF Layer is 0.008" thick Rogers Corp. RO40003C ( $\epsilon r = 3.35$ ). Metal layers are 0.5 oz. copper. The microstrip line at the connector interface is optimized for the Southwest Microwave end launch connector 1092-02A-5.

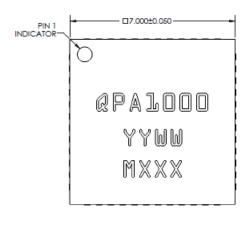
#### **Bill of Materials**

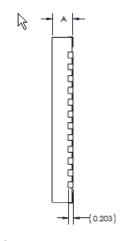
Ref. Des.	Component	Value	Manuf.	<b>Part Number</b>
C7, C21	Surface Mount Cap.	CAP, 1206, 10uF, 20%, 50V, 20%, X5R	Various	
C3, C6, C9, C12, C13, C16, C19, C22	Surface Mount Cap.	CAP, 0402, 1000pF, 10%, 100V, X7R	Various	
C8, C11, C20, C23	Surface Mount Cap.	CAP, 0402, 0.01uF, ±10%, 50V, X7R	Various	
R8, R10, R16, R19	Surface Mount Res.	RES, 10 OHM ± 5% 0402	Various	
R4, R13	Surface Mount Res.	RES, 10 OHM 1/10W ± 5% 0603	Various	
R6, R7, R16, R18	Surface Mount Res.	RES, 0 OHM 5% 0603	Various	

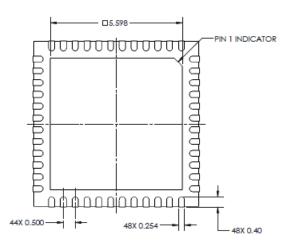


#### 2.8 - 3.2 GHz 50 Watt GaN Amplifier

#### **Mechanical Information**







MAX. 0.900 A NOM. 0.850 MIN 0.800

NOTES: PACKAGE METAL BASE AND LEADS ARE GOLD PLATED.

PART MARKING:

QPA1000: PART NUMBER YY: PART ASSY YEAR WW: PART ASSY WEEK MXXX: LOT NUMBER

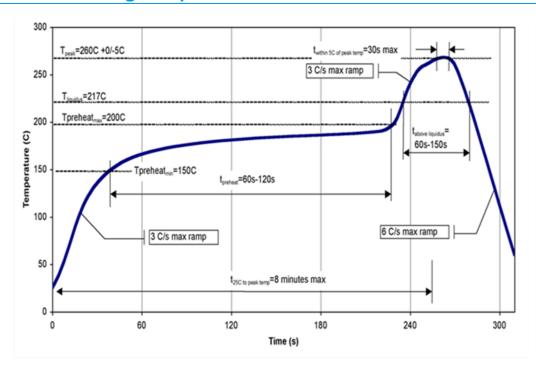
**DIMENSIONS IN MM** 

#### **Pin Description**

Pin Number	Symbol	Description
1-5, 8-12, 14, 16, 18-22, 24- 29, 32-37, 39-43, 45, 47	NC	No connection. Can be grounded on PCB if desired.
6, 7	RF Input	50 Ohm RF input. Pad is capacitively coupled to block on-chip DC voltages.
13, 48	V <sub>G1</sub>	$1^{st}$ Stage Gate Voltage; bias network is required; must be biased from both sides (V <sub>G1</sub> and V <sub>G2</sub> can be tied together in application)
15, 46	V <sub>D1</sub>	1st Stage Drain Voltage; bias network is required; must be biased from both sides (V <sub>D1</sub> and V <sub>D2</sub> can be tied together in application)
17, 44	V <sub>G2</sub>	$2^{nd}$ Stage Gate Voltage; bias network is required; must be biased from both sides (V <sub>G1</sub> and V <sub>G2</sub> can be tied together in application)
23, 38	V <sub>D2</sub>	$2^{nd}$ Stage Drain Voltage; bias network is required; must be biased from both sides (V <sub>D1</sub> and V <sub>D2</sub> can be tied together in application)
30, 31	RF Output	50 Ohm RF output. Pad is capacitively coupled to block on-chip DC voltages. Pad is DC grounded.
49	GND	Ground connection.



# **Recommended Soldering Temperature Profile**





#### 2.8 – 3.2 GHz 50 Watt GaN Amplifier

#### **Handling Precautions**

Parameter	Rating	Standard
ESD-Human Body Model (HBM)	Class 0B	ANSI/ESD/JEDEC JS-001
ESD-Charge Device Model (CDM)	Class C3	ANSI/ESD/JEDEC JS-002
MSL-Moisture Sensitivity Level	Level 3	IPC/JEDEC J-STD-020



#### **Solderability**

Compatible with the latest version of J-STD-020 Lead free solder, 260 °C. Solder profiles available upon request.

#### **RoHS Compliance**

This product is compliant with the 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment), as amended by Directive 2015/863/EU. This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C<sub>15</sub>H<sub>12</sub>Br<sub>4</sub>O<sub>2</sub>) Free
- PFOS Free
- SVHC Free
- Qorvo Green

#### **Contact Information**

For the latest specifications, additional product information, worldwide sales and distribution locations:

Tel: 1-844-890-8163
Web: <u>www.qorvo.com</u>

Email: <u>customer.support@qorvo.com</u>

#### **Important Notice**

The information contained herein is believed to be reliable; however, Qorvo makes no warranties regarding the information contained herein and assumes no responsibility or liability whatsoever for the use of the information contained herein. All information contained herein is subject to change without notice. Customers should obtain and verify the latest relevant information before placing orders for Qorvo products. The information contained herein or any use of such information does not grant, explicitly or implicitly, to any party any patent rights, licenses, or any other intellectual property rights, whether with regard to such information itself or anything described by such information. THIS INFORMATION DOES NOT CONSTITUTE A WARRANTY WITH RESPECT TO THE PRODUCTS DESCRIBED HEREIN, AND QORVO HEREBY DISCLAIMS ANY AND ALL WARRANTIES WITH RESPECT TO SUCH PRODUCTS WHETHER EXPRESS OR IMPLIED BY LAW, COURSE OF DEALING, COURSE OF PERFORMANCE, USAGE OF TRADE OR OTHERWISE, INCLUDING THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE.

Without limiting the generality of the foregoing, Qorvo products are not warranted or authorized for use as critical components in medical, life-saving, or life-sustaining applications, or other applications where a failure would reasonably be expected to cause severe personal injury or death.

Copyright 2021 © Qorvo, Inc. | Qorvo is a registered trademark of Qorvo, Inc.

# **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for RF Amplifier category:

Click to view products by Qorvo manufacturer:

Other Similar products are found below:

A82-1 BGA622H6820XTSA1 BGA 728L7 E6327 BGB719N7ESDE6327XTMA1 HMC397-SX HMC405 HMC561-SX HMC8120-SX HMC8121-SX HMC-ALH382-SX HMC-ALH476-SX SE2433T-R SMA3101-TL-E SMA39 A66-1 A66-3 A67-1 LX5535LQ LX5540LL MAAM02350 HMC3653LP3BETR HMC549MS8GETR HMC-ALH435-SX SMA101 SMA32 SMA411 SMA531 SST12LP17E-XX8E SST12LP19E-QX6E WPM0510A HMC5929LS6TR HMC5879LS7TR HMC1126 HMC1087F10 HMC1086 HMC1016 SMA1212 MAX2689EWS+T MAAMSS0041TR MAAM37000-A1G LTC6430AIUF-15#PBF CHA5115-QDG SMA70-2 SMA4011 A231 HMC-AUH232 LX5511LQ LX5511LQ-TR HMC7441-SX HMC-ALH310